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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, EBI/EMI, I²C, IrDA, LINbus, SmartCard, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, LCD, POR, PWM, WDT
Number of I/O	86
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	384K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.8V
Data Converters	A/D 16x12b SAR; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b310f2048gq100-a

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3.11 Memory Map

The EFM32GG11 memory map is shown in the figures below. RAM and flash sizes are for the largest memory configuration.

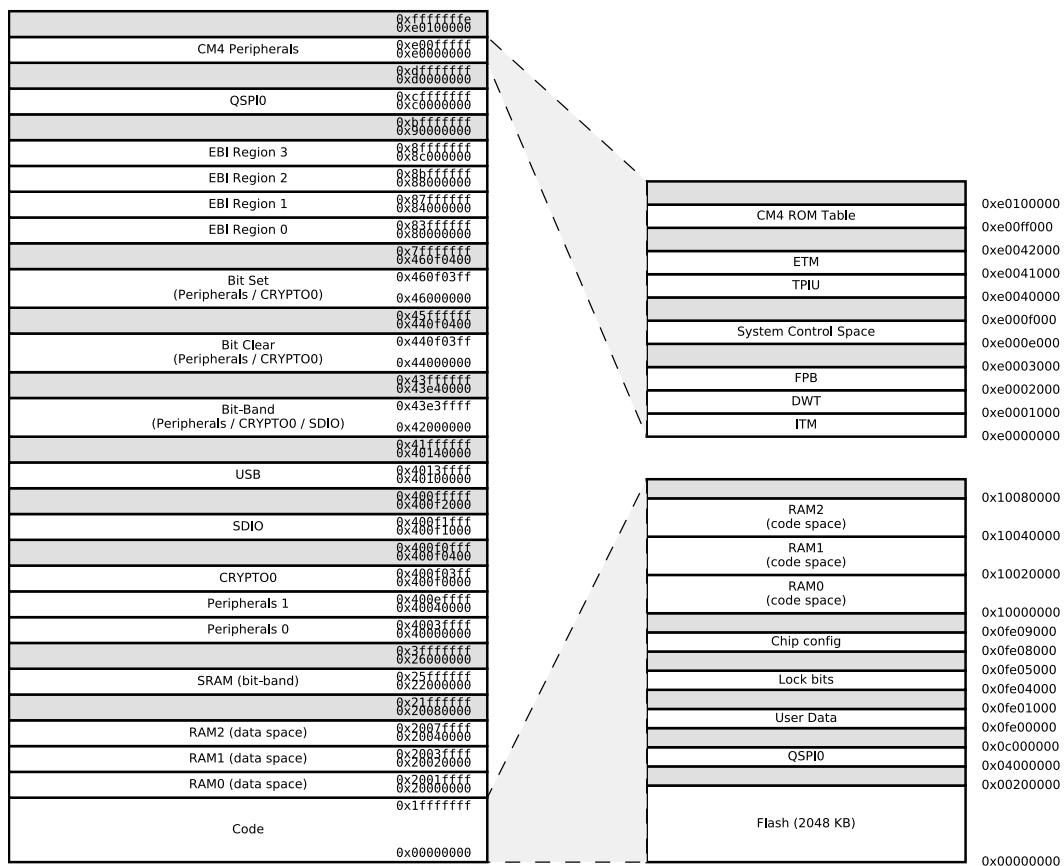


Figure 3.2. EFM32GG11 Memory Map — Core Peripherals and Code Space

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Output fall time, From 70% to 30% of V_{IO}	t_{IOOF}	$C_L = 50 \text{ pF}$, DRIVESTRENGTH ¹ = STRONG, SLEWRATE ¹ = 0x6	—	1.8	—	ns
		$C_L = 50 \text{ pF}$, DRIVESTRENGTH ¹ = WEAK, SLEWRATE ¹ = 0x6	—	4.5	—	ns
Output rise time, From 30% to 70% of V_{IO}	t_{IOOR}	$C_L = 50 \text{ pF}$, DRIVESTRENGTH ¹ = STRONG, SLEWRATE = 0x6 ¹	—	2.2	—	ns
		$C_L = 50 \text{ pF}$, DRIVESTRENGTH ¹ = WEAK, SLEWRATE ¹ = 0x6	—	7.4	—	ns

Note:

1. In GPIO_Pn_CTRL register.

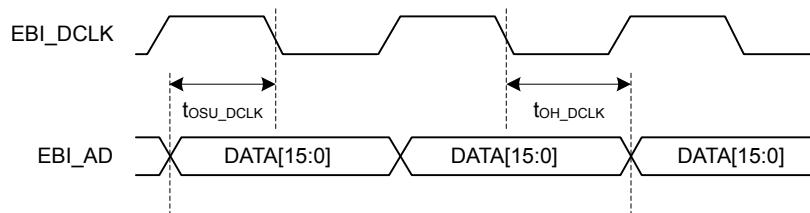
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Note:						
1.	Supply current specifications are for VDAC circuitry operating with static output only and do not include current required to drive the load.					
2.	In differential mode, the output is defined as the difference between two single-ended outputs. Absolute voltage on each output is limited to the single-ended range.					
3.	Entire range is monotonic and has no missing codes.					
4.	Current from HFFPERCLK is dependent on HFFPERCLK frequency. This current contributes to the total supply current used when the clock to the DAC module is enabled in the CMU.					
5.	Gain is calculated by measuring the slope from 10% to 90% of full scale. Offset is calculated by comparing actual VDAC output at 10% of full scale to ideal VDAC output at 10% of full scale with the measured gain.					
6.	PSRR calculated as $20 * \log_{10}(\Delta VDD / \Delta V_{OUT})$, VDAC output at 90% of full scale					

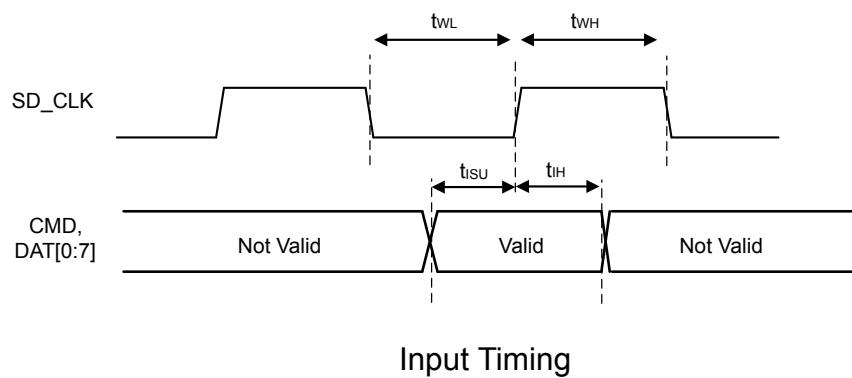
EBI TFT Output Timing

All numbers are based on route locations 0,1,2 only (with all EBI alternate functions using the same location at the same time). Timing is specified at 10% and 90% of IOVDD, 25 pF external loading, and slew rate for all GPIO set to 6.

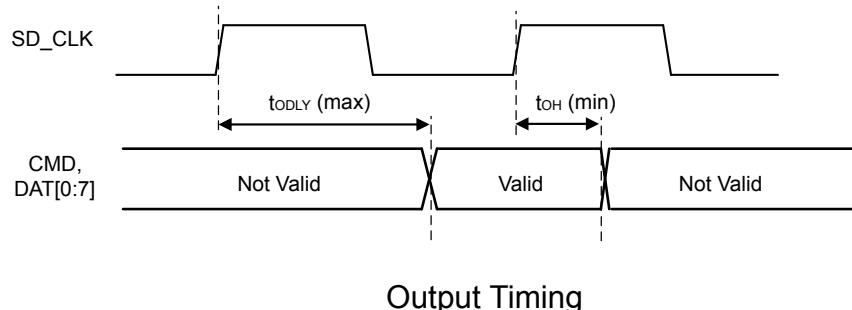
Table 4.39. EBI TFT Output Timing

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Output hold time, EBI_DCLK to EBI_AD invalid	t _{OH_DCLK}	IOVDD \geq 1.62 V	-23 + (TFTHOLD * t _{HFCOR-ECLK})	—	—	ns
		IOVDD \geq 3.0 V	-12 + (TFTHOLD * t _{HFCOR-ECLK})	—	—	ns
Output setup time, EBI_AD valid to EBI_DCLK	t _{OSU_DCLK}	IOVDD \geq 1.62 V	-11 + (TFTSET- UP * t _{HFCOR-ECLK})	—	—	ns
		IOVDD \geq 3.0 V	-9 + (TFTSET- UP * t _{HFCOR-ECLK})	—	—	ns

**Figure 4.6. EBI TFT Output Timing**



Input Timing



Output Timing

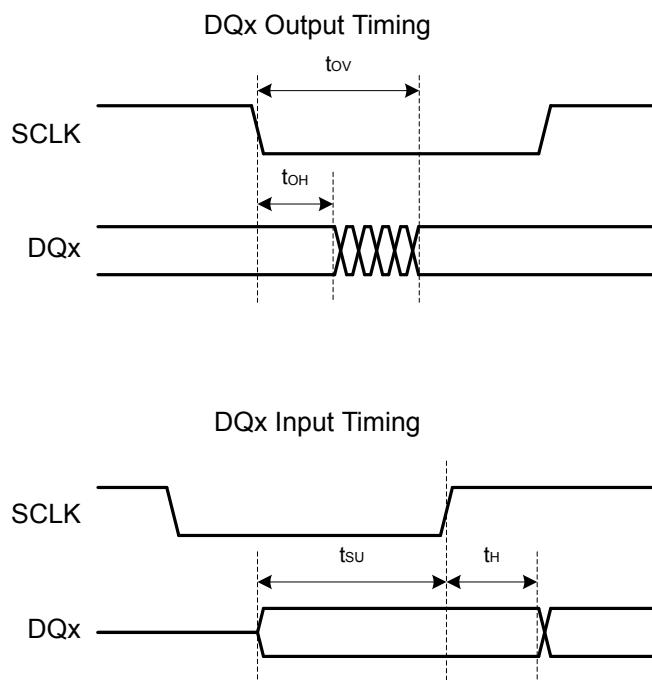
Figure 4.14. SDIO HS Mode Timing

QSPI SDR Mode Timing (Locations 1, 2)

Timing is specified with voltage scaling disabled, PHY-mode, route locations other than 0, TX DLL = 34, RX DLL = 59, 20-25 pF loading per GPIO, and slew rate for all GPIO set to 6, DRIVESTRENGTH = STRONG.

Table 4.55. QSPI SDR Mode Timing (Locations 1, 2)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Full SCLK period	T		(1/ F_{SCLK}) * 0.95	—	—	ns
Output valid	t_{OV}		—	—	$T/2 - 2.1$	ns
Output hold	t_{OH}		$T/2 - 42.3$	—	—	ns
Input setup	t_{SU}		48.2 - $T/2$	—	—	ns
Input hold	t_H		$T/2 - 5.1$	—	—	ns

**Figure 4.21. QSPI SDR Timing Diagrams****QSPI SDR Flash Timing Example**

This example uses timing values for location 0 (SDR mode) to demonstrate the calculation of allowable flash timing using the QSPI in SDR mode.

- Using a configured SCLK frequency (F_{SCLK}) of 19 MHz:
- The resulting minimum period, $T(\min) = (1/F_{SCLK}) * 0.95 = 50.0 \text{ ns}$.
- Flash will see a minimum setup time of $T/2 - t_{OV} = T/2 - (T/2 - 2.4) = 2.4 \text{ ns}$.
- Flash will see a minimum hold time of $T/2 + t_{OH} = T/2 + (T/2 - 32.9) = T - 32.9 = 50.0 - 32.9 = 17.1 \text{ ns}$.
- Flash can have a maximum output valid time of $T/2 - t_{SU} = T/2 - (36.2 - T/2) = T - 36.2 = 50.0 - 36.2 = 13.8 \text{ ns}$.
- Flash can have a minimum output hold time of $t_H - T/2 = (T/2 - 3.3) - T/2 = -3.3 \text{ ns}$.

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
VBUS	A13	USB VBUS signal and auxiliary input to 5 V regulator.	PF11	A14	GPIO (5V)
PF10	A15	GPIO (5V)	PF0	A16	GPIO (5V)
PA0	B1	GPIO	PD11	B2	GPIO
PD10	B3	GPIO	PD9	B4	GPIO
PF9	B5	GPIO	PF8	B6	GPIO
PF7	B7	GPIO	PF6	B8	GPIO
PI11	B9	GPIO (5V)	PI8	B10	GPIO (5V)
PF5	B11	GPIO	PF13	B12	GPIO (5V)
PF3	B13	GPIO	PF2	B14	GPIO
PF1	B15	GPIO (5V)	VREGO	B16	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs
PA1	C1	GPIO	PD12	C2	GPIO
PD14	C3	GPIO (5V)	PD13	C4	GPIO (5V)
PI15	C5	GPIO (5V)	PI14	C6	GPIO (5V)
PI13	C7	GPIO (5V)	PI12	C8	GPIO (5V)
PI10	C9	GPIO (5V)	PI7	C10	GPIO (5V)
PF15	C11	GPIO (5V)	PF12	C12	GPIO
PF4	C13	GPIO	PC15	C14	GPIO (5V)
PC14	C15	GPIO (5V)	VREGI	C16	Input to 5 V regulator.
PA2	D1	GPIO	PG0	D2	GPIO (5V)
PD15	D3	GPIO (5V)	PC13	D14	GPIO (5V)
PC12	D15	GPIO (5V)	PC11	D16	GPIO (5V)
PA3	E1	GPIO	PG2	E2	GPIO (5V)
PG1	E3	GPIO (5V)	PC10	E14	GPIO (5V)
PC9	E15	GPIO (5V)	PC8	E16	GPIO (5V)
PA4	F1	GPIO	PG4	F2	GPIO (5V)
PG3	F3	GPIO (5V)	IOVDD2	F6 G6	Digital IO power supply 2.

5.8 EFM32GG11B8xx in QFP100 Device Pinout

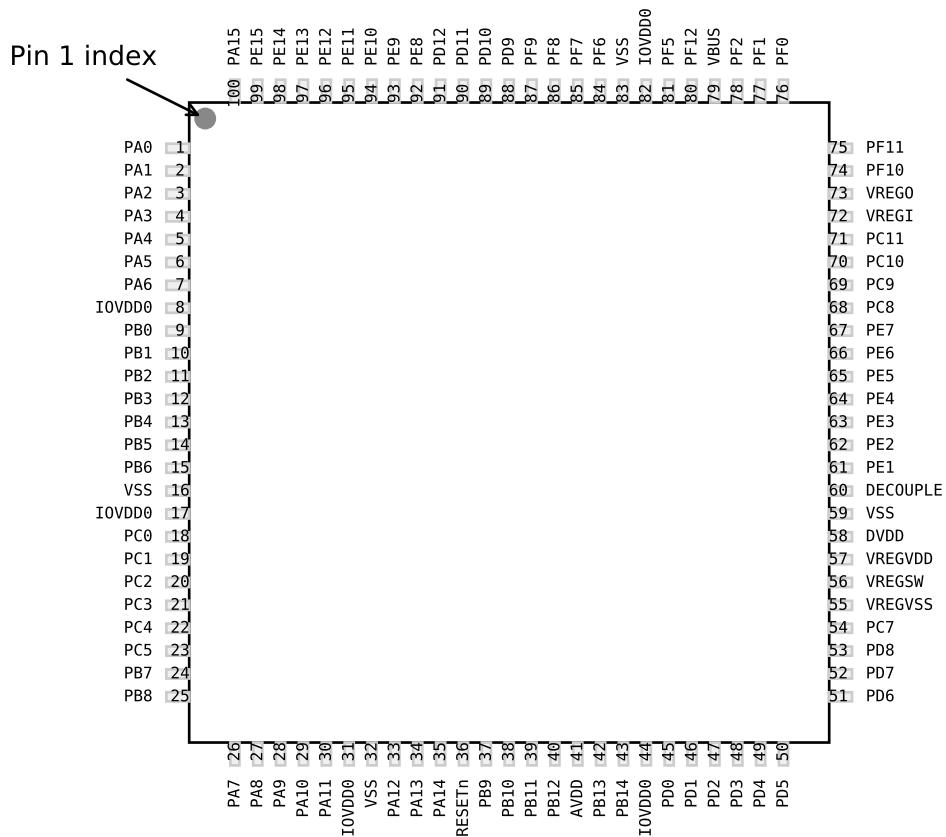


Figure 5.8. EFM32GG11B8xx in QFP100 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

Table 5.8. EFM32GG11B8xx in QFP100 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PA0	1	GPIO	PA1	2	GPIO
PA2	3	GPIO	PA3	4	GPIO
PA4	5	GPIO	PA5	6	GPIO
PA6	7	GPIO	IOVDD0	8 17 31 44 82	Digital IO power supply 0.
PB0	9	GPIO	PB1	10	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PB2	11	GPIO	PB3	12	GPIO
PB4	13	GPIO	PB5	14	GPIO
PB6	15	GPIO	VSS	16 32 58 83	Ground
PC0	18	GPIO (5V)	PC1	19	GPIO (5V)
PC2	20	GPIO (5V)	PC3	21	GPIO (5V)
PC4	22	GPIO	PC5	23	GPIO
PB7	24	GPIO	PB8	25	GPIO
PA7	26	GPIO	PA8	27	GPIO
PA9	28	GPIO	PA10	29	GPIO
PA11	30	GPIO	PA12	33	GPIO (5V)
PA13	34	GPIO (5V)	PA14	35	GPIO
RESETn	36	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB9	37	GPIO (5V)
PB10	38	GPIO (5V)	PB11	39	GPIO
PB12	40	GPIO	AVDD	41 45	Analog power supply.
PB13	42	GPIO	PB14	43	GPIO
PD0	46	GPIO (5V)	PD1	47	GPIO
PD2	48	GPIO (5V)	PD3	49	GPIO
PD4	50	GPIO	PD5	51	GPIO
PD6	52	GPIO	PD7	53	GPIO
PD8	54	GPIO	PC6	55	GPIO
PC7	56	GPIO	DVDD	57	Digital power supply.
DECOPPLE	59	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PE0	60	GPIO (5V)
PE1	61	GPIO (5V)	PE2	62	GPIO
PE3	63	GPIO	PE4	64	GPIO
PE5	65	GPIO	PE6	66	GPIO
PE7	67	GPIO	PC8	68	GPIO (5V)
PC9	69	GPIO (5V)	PC10	70	GPIO (5V)
PC11	71	GPIO (5V)	VREGI	72	Input to 5 V regulator.
VREGO	73	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs	PF10	74	GPIO (5V)
PF11	75	GPIO (5V)	PF0	76	GPIO (5V)

5.11 EFM32GG11B3xx in QFP100 Device Pinout

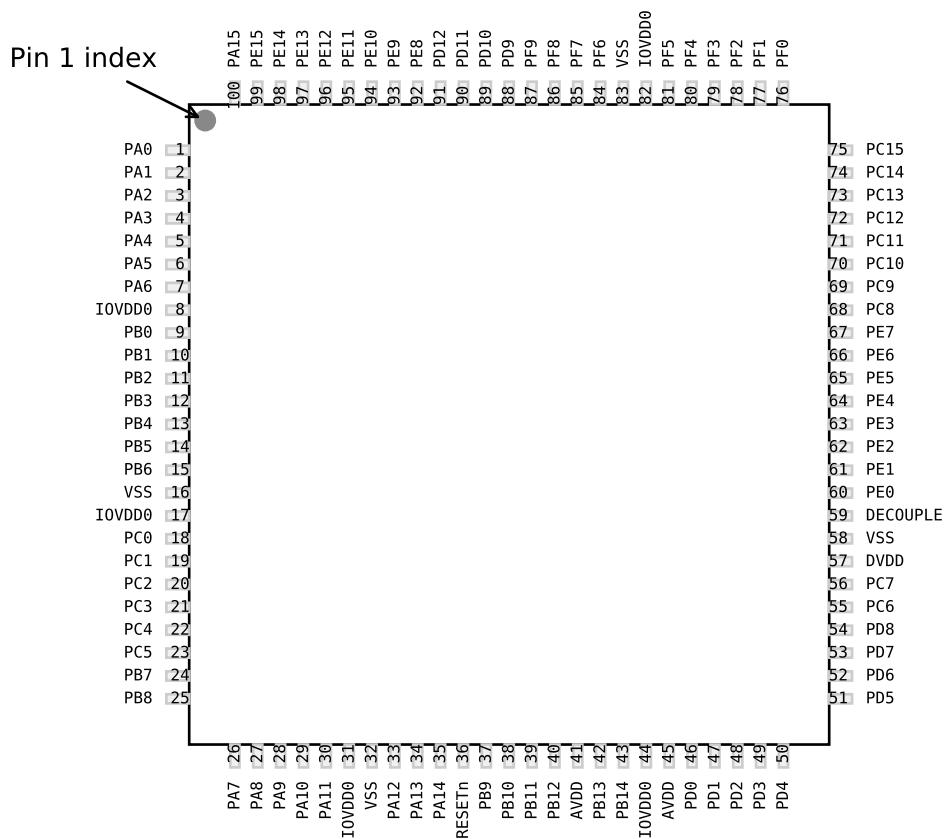


Figure 5.11. EFM32GG11B3xx in QFP100 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

Table 5.11. EFM32GG11B3xx in QFP100 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PA0	1	GPIO	PA1	2	GPIO
PA2	3	GPIO	PA3	4	GPIO
PA4	5	GPIO	PA5	6	GPIO
PA6	7	GPIO	IOVDD0	8 17 31 44 82	Digital IO power supply 0.
PB0	9	GPIO	PB1	10	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PB2	11	GPIO	PB3	12	GPIO
PB4	13	GPIO	PB5	14	GPIO
PB6	15	GPIO	VSS	16 32 58 83	Ground
PC0	18	GPIO (5V)	PC1	19	GPIO (5V)
PC2	20	GPIO (5V)	PC3	21	GPIO (5V)
PC4	22	GPIO	PC5	23	GPIO
PB7	24	GPIO	PB8	25	GPIO
PA7	26	GPIO	PA8	27	GPIO
PA9	28	GPIO	PA10	29	GPIO
PA11	30	GPIO	PA12	33	GPIO (5V)
PA13	34	GPIO (5V)	PA14	35	GPIO
RESETn	36	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB9	37	GPIO (5V)
PB10	38	GPIO (5V)	PB11	39	GPIO
PB12	40	GPIO	AVDD	41 45	Analog power supply.
PB13	42	GPIO	PB14	43	GPIO
PD0	46	GPIO (5V)	PD1	47	GPIO
PD2	48	GPIO (5V)	PD3	49	GPIO
PD4	50	GPIO	PD5	51	GPIO
PD6	52	GPIO	PD7	53	GPIO
PD8	54	GPIO	PC6	55	GPIO
PC7	56	GPIO	DVDD	57	Digital power supply.
DECOPPLE	59	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PE0	60	GPIO (5V)
PE1	61	GPIO (5V)	PE2	62	GPIO
PE3	63	GPIO	PE4	64	GPIO
PE5	65	GPIO	PE6	66	GPIO
PE7	67	GPIO	PC8	68	GPIO (5V)
PC9	69	GPIO (5V)	PC10	70	GPIO (5V)
PC11	71	GPIO (5V)	PC12	72	GPIO (5V)
PC13	73	GPIO (5V)	PC14	74	GPIO (5V)
PC15	75	GPIO (5V)	PF0	76	GPIO (5V)
PF1	77	GPIO (5V)	PF2	78	GPIO

5.15 EFM32GG11B1xx in QFP64 Device Pinout

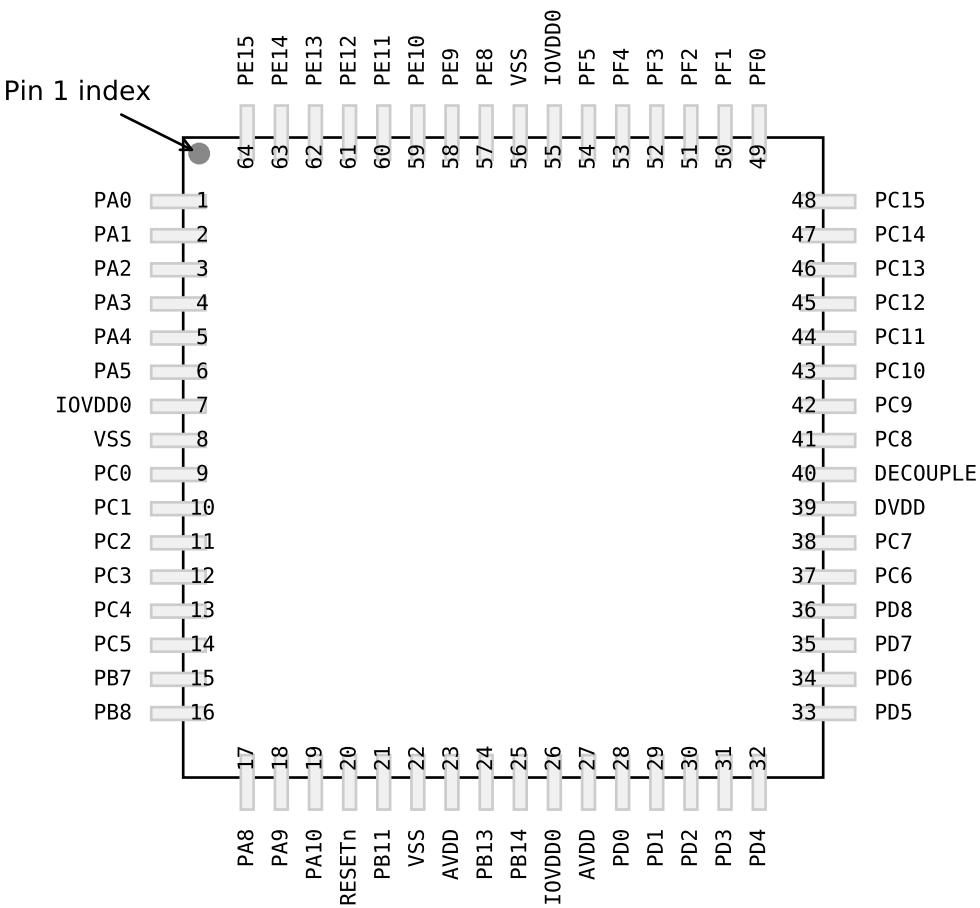


Figure 5.15. EFM32GG11B1xx in QFP64 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

Table 5.15. EFM32GG11B1xx in QFP64 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PA0	1	GPIO	PA1	2	GPIO
PA2	3	GPIO	PA3	4	GPIO
PA4	5	GPIO	PA5	6	GPIO
IOVDD0	7 26 55	Digital IO power supply 0.	VSS	8 22 56	Ground
PC0	9	GPIO (5V)	PC1	10	GPIO (5V)
PC2	11	GPIO (5V)	PC3	12	GPIO (5V)

5.20 GPIO Functionality Table

A wide selection of alternate functionality is available for multiplexing to various pins. The following table shows the name of each GPIO pin, followed by the functionality available on that pin. Refer to [5.21 Alternate Functionality Overview](#) for a list of GPIO locations available for each function.

Table 5.20. GPIO Functionality Table

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PA15	BUSAY BUSBX LCD_SEG12	EBI_AD08 #0	TIM3_CC2 #0	ETH_MIIRXCLK #0 ETH_MDIO #3 US2_CLK #3	PRS_CH15 #0
PE15	BUSCY BUSDX LCD_SEG11	EBI_AD07 #0	TIM2_CDTI2 #2 TIM3_CC1 #0	ETH_RMIITXD0 #0 ETH_MIIRXD3 #0 SDIO_CMD #1 US0 RTS #0 QSPI0_DQS #1 LEU0_RX #2	PRS_CH14 #2 ETM_TD3 #4
PE14	BUSDY BUSCX LCD_SEG10	EBI_AD06 #0	TIM2_CDTI1 #2 TIM3_CC0 #0	ETH_RMIITXD1 #0 ETH_MIIRXD2 #0 SDIO_CLK #1 US0_CTS #0 QSPI0_SCLK #1 LEU0_TX #2	PRS_CH13 #2 ETM_TD2 #4
PE13	BUSCY BUSDX LCD_SEG9	EBI_AD05 #0	TIM1_CC3 #1 TIM2_CC2 #3 LE-TIM0_OUT1 #4	SDIO_CLK #0 ETH_MIIRXD1 #0 US0_TX #3 US0_CS #0 U1_RX #4 I2C0_SCL #6	LES_ALTEX7 PRS_CH2 #3 ACMP0_O #0 ETM_TD1 #4 GPIO_EM4WU5
PE12	BUSDY BUSCX LCD_SEG8	EBI_AD04 #0	TIM1_CC2 #1 TIM2_CC1 #3 WTIM0_CDTI2 #0 LETIM0_OUT0 #4	SDIO_CMD #0 ETH_MIIRXD0 #0 US0_RX #3 US0_CLK #0 U1_TX #4 I2C0_SDA #6	CMU_CLK1 #2 CMU_CLKI0 #6 LES_ALTEX6 PRS_CH1 #3 ETM_TD0 #4
PE11	BUSCY BUSDX LCD_SEG7	EBI_AD03 #0 EBI_CS3 #4	TIM1_CC1 #1 TIM4_CC2 #7 WTIM0_CDTI1 #0	SDIO_DAT0 #0 QSPI0_DQ7 #0 ETH_MIIRXDV #0 US0_RX #0	LES_ALTEX5 PRS_CH3 #2 ETM_TCLK #4
PE10	BUSDY BUSCX LCD_SEG6	EBI_AD02 #0 EBI_CS2 #4	TIM1_CC0 #1 TIM4_CC1 #7 WTIM0_CDTI0 #0	SDIO_DAT1 #0 QSPI0_DQ6 #0 ETH_MIIRXER #0 US0_TX #0	PRS_CH2 #2 GPIO_EM4WU9
PE9	BUSCY BUSDX LCD_SEG5	EBI_AD01 #0 EBI_CS1 #4	TIM4_CC0 #7 PCNT2_S1IN #1	SDIO_DAT2 #0 QSPI0_DQ5 #0 US5_RX #0	PRS_CH8 #2
PE8	BUSDY BUSCX LCD_SEG4	EBI_AD00 #0 EBI_CS0 #4	TIM2_CDTI0 #2 TIM4_CC2 #6 PCNT2_S0IN #1	SDIO_DAT3 #0 QSPI0_DQ4 #0 US5_TX #0 I2C2_SDA #0	PRS_CH3 #1
PI9		EBI_A14 #2	TIM1_CC3 #7 TIM4_CC1 #3	US4_CS #3	
PI6		EBI_A11 #2	TIM1_CC0 #7 TIM4_CC1 #2 WTIM3_CC0 #5	US4_TX #3	

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
DBG_SWO	0: PF2 1: PC15 2: PD1 3: PD2		Debug-interface Serial Wire viewer Output. Note that this function is not enabled after reset, and must be enabled by software to be used.
DBG_TDI	0: PF5		Debug-interface JTAG Test Data In. Note that this function becomes available after the first valid JTAG command is received, and has a built-in pull up when JTAG is active.
DBG_TDO	0: PF2		Debug-interface JTAG Test Data Out. Note that this function becomes available after the first valid JTAG command is received.
EBI_A00	0: PA12 1: PB9 2: PE0 3: PC5		External Bus Interface (EBI) address output pin 00.
EBI_A01	0: PA13 1: PB10 2: PE1 3: PA7		External Bus Interface (EBI) address output pin 01.
EBI_A02	0: PA14 1: PB11 2: PI0 3: PA8		External Bus Interface (EBI) address output pin 02.
EBI_A03	0: PB9 1: PB12 2: PI1 3: PA9		External Bus Interface (EBI) address output pin 03.
EBI_A04	0: PB10 1: PD0 2: PI2 3: PA10		External Bus Interface (EBI) address output pin 04.
EBI_A05	0: PC6 1: PD1 2: PI3 3: PA11		External Bus Interface (EBI) address output pin 05.
EBI_A06	0: PC7 1: PD2 2: PI4 3: PA12		External Bus Interface (EBI) address output pin 06.
EBI_A07	0: PE0 1: PD3 2: PI5 3: PA13		External Bus Interface (EBI) address output pin 07.
EBI_A08	0: PE1 1: PD4 2: PC8 3: PA14		External Bus Interface (EBI) address output pin 08.
EBI_A09	0: PE2 1: PD5 2: PC9 3: PB9		External Bus Interface (EBI) address output pin 09.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
ETH_MDIO	0: PB3 1: PD13 2: PC0 3: PA15		Ethernet Management Data I/O.
ETH_MIICOL	0: PB2 1: PG15 2: PB4		Ethernet MII Collision Detect.
ETH_MIICRS	0: PB1 1: PG14 2: PB3		Ethernet MII Carrier Sense.
ETH_MIIRXCLK	0: PA15 1: PG7 2: PD12		Ethernet MII Receive Clock.
ETH_MIIRXD0	0: PE12 1: PG11 2: PF9		Ethernet MII Receive Data Bit 0.
ETH_MIIRXD1	0: PE13 1: PG10 2: PD9		Ethernet MII Receive Data Bit 1.
ETH_MIIRXD2	0: PE14 1: PG9 2: PD10		Ethernet MII Receive Data Bit 2.
ETH_MIIRXD3	0: PE15 1: PG8 2: PD11		Ethernet MII Receive Data Bit 3.
ETH_MIIRXDV	0: PE11 1: PG12 2: PF8		Ethernet MII Receive Data Valid.
ETH_MIIRXER	0: PE10 1: PG13 2: PF7		Ethernet MII Receive Error.
ETH_MIITXCLK	0: PA0 1: PG0		Ethernet MII Transmit Clock.
ETH_MIITXD0	0: PA4 1: PG4		Ethernet MII Transmit Data Bit 0.
ETH_MIITXD1	0: PA3 1: PG3		Ethernet MII Transmit Data Bit 1.

Table 5.26. ACMP3 Bus and Pin Mapping

	APORT4Y	APORT4X	APORT3Y	APORT3X	APORT2Y	APORT2X	APORT1Y	APORT1X	APORT0Y	APORT0X	Port
BUSDY	BUSDX	BUSCY	BUSCX	BUSBY	BUSBX	BUSAY	BUSAX	BUSACMP3Y	BUSACMP3X	BUS	CH31
PF15	PF15			PB15		PB15					CH30
PF14		PF14		PB14			PB14				CH29
PF13	PF13			PB13	PB13		PB12				CH28
PF12		PF12		PB12		PB11	PB11				CH27
PF10	PF11	PF11		PB10		PB10	PB10				CH26
PF8		PF9	PF9		PB9	PB9	PB9				CH25
PF7	PF7		PF8								CH24
PF6	PF5	PF5	PF6	PB6	PB6	PB5	PB5	PB6			CH23
PF4		PF4	PF4	PB4	PB4	PB3	PB3	PB4			CH22
PF2	PF1	PF1	PF2	PB2	PB2	PB1	PB1	PB2			CH21
PF0		PF3	PF3	PB0	PB0	PB0	PB0	PB0			CH20
PE15	PE15		PE15	PE15		PA15	PA15	PA14			CH19
PE14		PE13	PE13	PE14	PE14	PA13	PA13	PA14			CH18
PE12		PE11	PE11	PE12	PE12	PA12	PA12	PA12			CH17
PE10		PE10		PE10	PE10	PA11	PA11	PA11			CH16
PE8		PE9	PE9	PE8	PE8	PA9	PA9	PA9			CH15
PE6		PE7	PE7	PE6	PE6	PA8	PA8	PA8			CH14
PE5		PE5		PE5		PA7	PA7	PA7			CH13
PE4			PE4		PE4	PA5	PA5	PA6	PA6	PA6	CH12
					PA4	PA4	PA4	PA4	PA4	PA4	CH11
					PA3	PA3	PA3	PA3	PA3	PA3	CH10
PE1		PE1		PE1		PA2	PA2	PA2	PA2	PA2	PA2
PE0			PE0	PE0	PE0	PA1	PA1	PA1	PA1	PA1	PA1

Table 5.27. ADC0 Bus and Pin Mapping

APORT4Y	APORT4X	APORT3Y	APORT3X	APORT2Y	APORT2X	APORT1Y	APORT1X	APORT0Y	APORT0X	Port
BUSDY	BUSDX	BUSCY	BUSCX	BUSBY	BUSBX	BUSA Y	BUSA X	BUSADC0 Y	BUSADC0 X	Bus
PF15	PF15			PF15	PF15					CH31
PF14	PF13	PF13		PF14	PF14		PF14			CH30
PF12	PF11	PF11		PF12	PF12		PF12			CH29
PF10	PF9	PF9		PF10	PF10		PF11			CH28
PF8	PF7	PF7		PF8	PF8		PF9	PF9		CH27
PF6	PF5	PF5		PF6	PF6		PF6	PF6		CH26
PF4	PF3	PF3		PF4	PF4		PF5	PF5		CH25
PF2	PF1	PF1		PF2	PF2		PF3	PF3		CH24
PF0	PE15	PE15		PF0	PF0		PF1	PF1		CH23
PE14	PE13	PE13		PE14	PE14		PE12	PE12		CH22
PE12	PE11	PE11		PE10	PE10		PA13	PA13		CH21
PE10	PE9	PE9		PE10	PE10		PA11	PA11		CH20
PE8	PE7	PE7		PE8	PE8		PA10	PA10		CH19
PE6	PE5	PE5		PE6	PE6		PA9	PA9		CH18
PE4				PE4	PE4		PA8	PA8		CH17
							PA7	PA7		CH16
							PA6	PA6		CH15
							PA5	PA5		CH14
							PA14	PA14		CH13
							PA12	PA12		CH12
							PA11	PA11		CH11
							PA10	PA10		CH10
							PA9	PA9		CH9
							PA8	PA8		CH8
							PA7	PA7		CH7
							PD7	PD7		PD7
							PD6	PD6		PD6
							PD5	PD5		PD5
							PD4	PD4		PD4
							PD3	PD3		PD3
							PD2	PD2		PD2
							PD1	PD1		PD1
							PD0	PD0		PD0
							PA0	PA0		PA0

7. BGA152 Package Specifications

7.1 BGA152 Package Dimensions

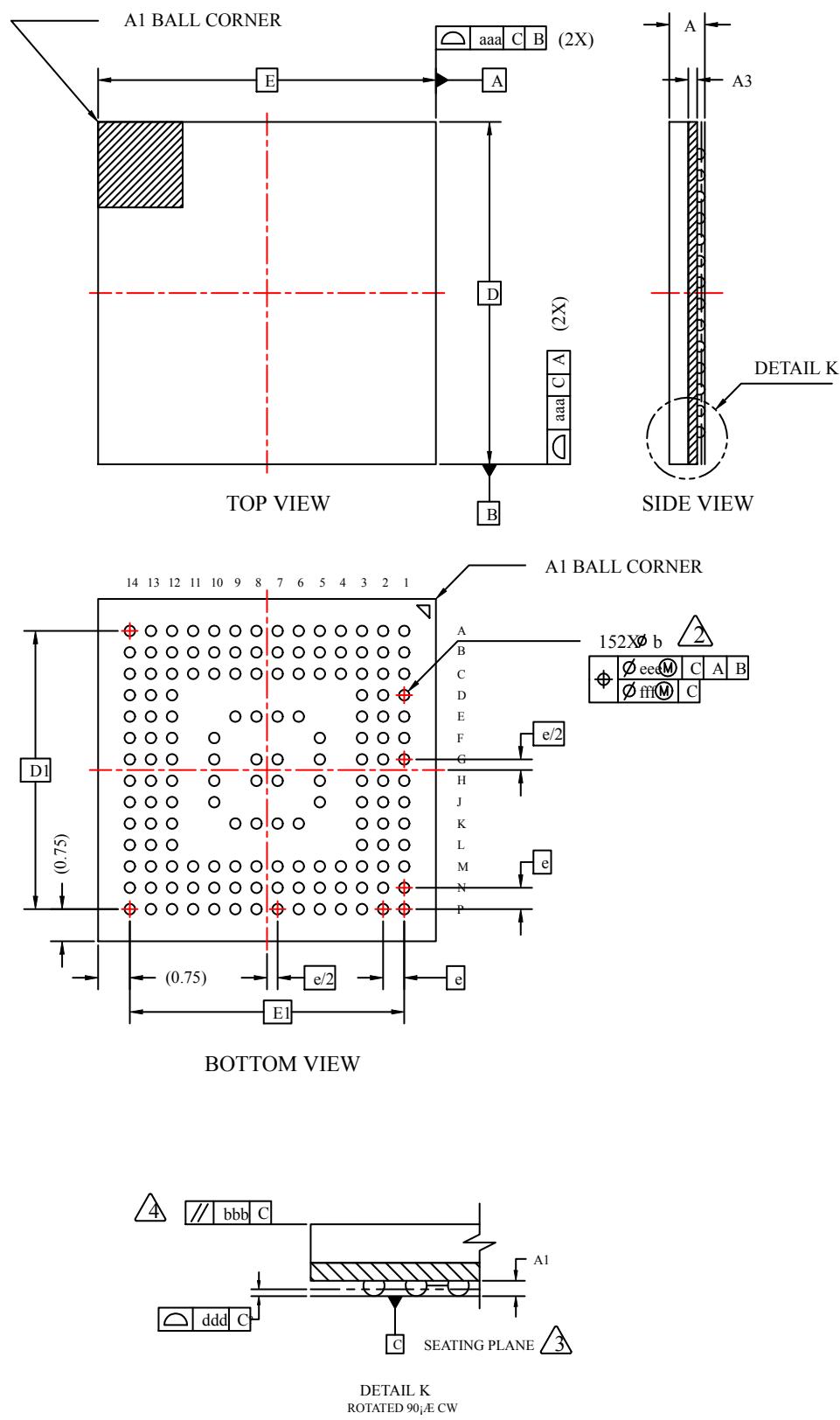


Figure 7.1. BGA152 Package Drawing

7.2 BGA152 PCB Land Pattern

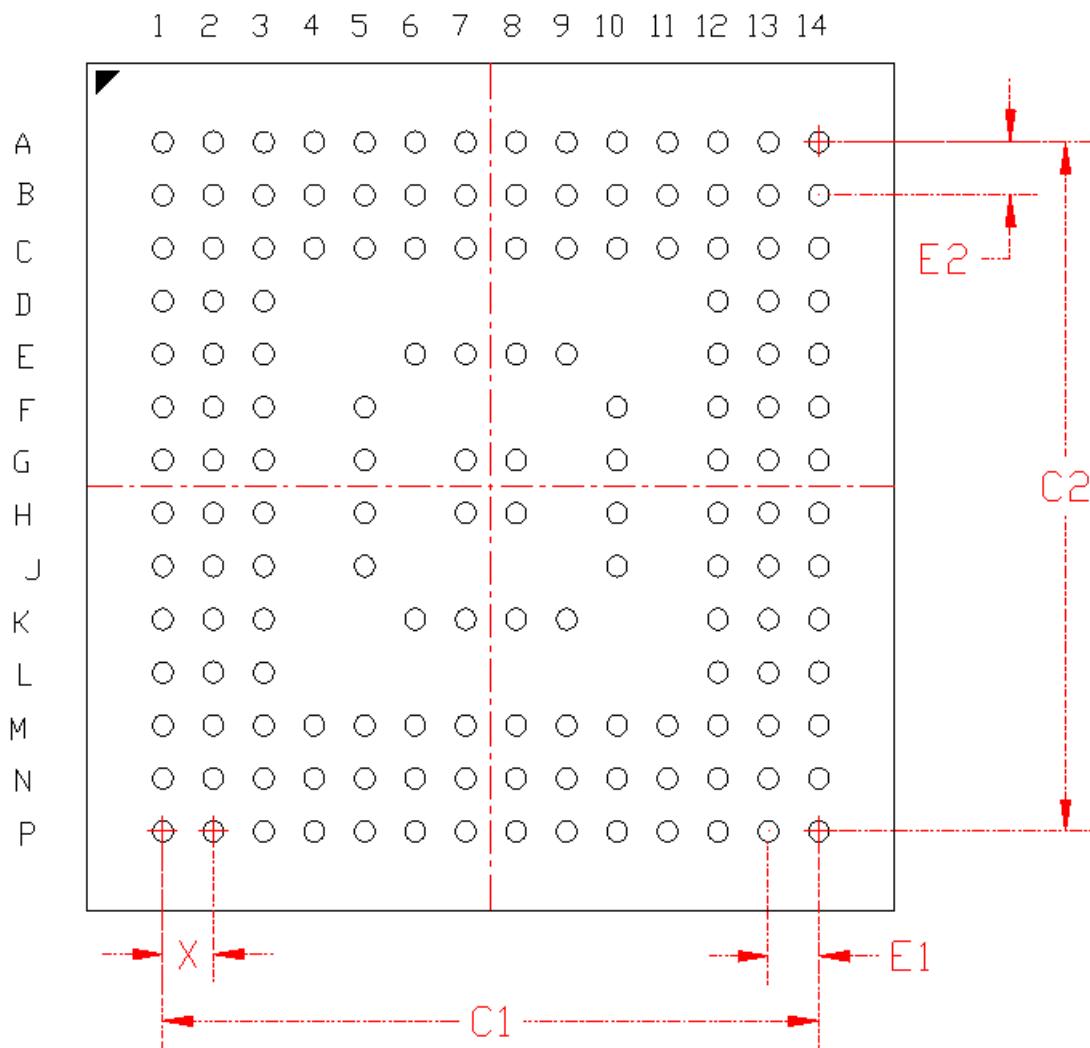


Figure 7.2. BGA152 PCB Land Pattern Drawing